

# IPI80N06S207AKSA1 Datasheet



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DiGi Electronics Part Number	IPI80N06S207AKSA1-DG
Manufacturer	<a href="#">Infineon Technologies</a>
Manufacturer Product Number	IPI80N06S207AKSA1
Description	MOSFET N-CH 55V 80A TO262-3
Detailed Description	N-Channel 55 V 80A (Tc) 250W (Tc) Through Hole P G-TO262-3



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## Purchase and inquiry

### Manufacturer Product Number:

IPI80N06S207AKSA1

### Series:

OptiMOS™

### FET Type:

N-Channel

### Drain to Source Voltage (Vdss):

55 V

### Drive Voltage (Max Rds On, Min Rds On):

10V

### Vgs(th) (Max) @ Id:

4V @ 180µA

### Vgs (Max):

±20V

### FET Feature:

-

### Operating Temperature:

-55°C ~ 175°C (Tj)

### Supplier Device Package:

PG-T0262-3

### Base Product Number:

IPI80N

### Manufacturer:

Infineon Technologies

### Product Status:

Discontinued at Digi-Key

### Technology:

MOSFET (Metal Oxide)

### Current - Continuous Drain (Id) @ 25°C:

80A (Tc)

### Rds On (Max) @ Id, Vgs:

6.6mOhm @ 68A, 10V

### Gate Charge (Qg) (Max) @ Vgs:

110 nC @ 10 V

### Input Capacitance (Ciss) (Max) @ Vds:

3400 pF @ 25 V

### Power Dissipation (Max):

250W (Tc)

### Mounting Type:

Through Hole

### Package / Case:

TO-262-3 Long Leads, I2PAK, TO-262AA

## Environmental & Export classification

### RoHS Status:

ROHS3 Compliant

### REACH Status:

REACH Unaffected

### HTSUS:

8541.29.0095

### Moisture Sensitivity Level (MSL):

1 (Unlimited)

### ECCN:

EAR99



**IPB80N06S2-07**

**IPP80N06S2-07, IPI80N06S2-07**

**OptiMOS® Power-Transistor**

**Features**

- N-channel - Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green package (lead free)
- Ultra low Rds(on)
- 100% Avalanche tested

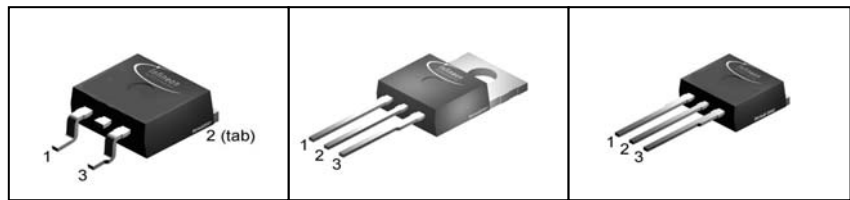
**Product Summary**

$V_{DS}$	55	V
$R_{DS(on),max}$ (SMD version)	6.3	mΩ
$I_D$	80	A

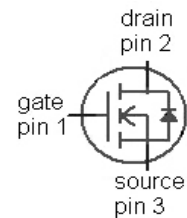
PG-TO263-3-2

PG-TO220-3-1

PG-TO262-3-1



Type	Package	Ordering Code	Marking
IPB80N06S2-07	PG-TO263-3-2	SP0002-18818	2N0607
IPP80N06S2-07	PG-TO220-3-1	SP0002-18810	2N0607
IPI80N06S2-07	PG-TO262-3-1	SP0002-18817	2N0607



**Maximum ratings, at  $T_j=25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current <sup>1)</sup>	$I_D$	$T_C=25\text{ °C}$ , $V_{GS}=10\text{ V}$	80	A
		$T_C=100\text{ °C}$ , $V_{GS}=10\text{ V}^{2)}$	80	
Pulsed drain current <sup>2)</sup>	$I_{D,pulse}$	$T_C=25\text{ °C}$	320	
Avalanche energy, single pulse <sup>2)</sup>	$E_{AS}$	$I_D=80\text{ A}$	530	mJ
Gate source voltage <sup>4)</sup>	$V_{GS}$		±20	V
Power dissipation	$P_{tot}$	$T_C=25\text{ °C}$	250	W
Operating and storage temperature	$T_j, T_{stg}$		-55 ... +175	°C
IEC climatic category; DIN IEC 68-1			55/175/56	



IPB80N06S2-07

IPP80N06S2-07, IPI80N06S2-07

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
<b>Thermal characteristics<sup>2)</sup></b>						
Thermal resistance, junction - case	$R_{thJC}$		-	-	0.6	K/W
Thermal resistance, junction - ambient, leaded	$R_{thJA}$		-	-	62	
SMD version, device on PCB	$R_{thJA}$	minimal footprint	-	-	62	
		6 cm <sup>2</sup> cooling area <sup>5)</sup>	-	-	40	

**Electrical characteristics, at  $T_j=25\text{ °C}$ , unless otherwise specified**

#### Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{ V}, I_D=1\text{ mA}$	55	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=180\text{ }\mu\text{A}$	2.1	3.0	4.0	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=55\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ °C}$	-	0.01	1	$\mu\text{A}$
		$V_{DS}=55\text{ V}, V_{GS}=0\text{ V}, T_j=125\text{ °C}^{2)}$	-	1	100	
Gate-source leakage current	$I_{GSS}$	$V_{GS}=20\text{ V}, V_{DS}=0\text{ V}$	-	1	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10\text{ V}, I_D=68\text{ A},$	-	5.6	6.6	m $\Omega$
		$V_{GS}=10\text{ V}, I_D=68\text{ A},$ SMD version	-	5.3	6.3	



IPB80N06S2-07

IPP80N06S2-07, IPI80N06S2-07

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Dynamic characteristics<sup>2)</sup>**

Input capacitance	$C_{iss}$	$V_{GS}=0\text{ V}, V_{DS}=25\text{ V},$ $f=1\text{ MHz}$	-	3400	-	pF
Output capacitance	$C_{oss}$		-	880	-	
Reverse transfer capacitance	$C_{rss}$		-	215	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=30\text{ V}, V_{GS}=10\text{ V},$ $I_D=80\text{ A}, R_G=3.3\ \Omega$	-	16	-	ns
Rise time	$t_r$		-	37	-	
Turn-off delay time	$t_{d(off)}$		-	61	-	
Fall time	$t_f$		-	36	-	

**Gate Charge Characteristics<sup>2)</sup>**

Gate to source charge	$Q_{gs}$	$V_{DD}=44\text{ V}, I_D=80\text{ A},$ $V_{GS}=0\text{ to }10\text{ V}$	-	18	24	nC
Gate to drain charge	$Q_{gd}$		-	35	53	
Gate charge total	$Q_g$		-	86	110	
Gate plateau voltage	$V_{plateau}$		-	4.9	-	V

**Reverse Diode**

Diode continuous forward current <sup>2)</sup>	$I_S$	$T_C=25\text{ }^\circ\text{C}$	-	-	80	A
Diode pulse current <sup>2)</sup>	$I_{S,pulse}$		-	-	320	
Diode forward voltage	$V_{SD}$	$V_{GS}=0\text{ V}, I_F=80\text{ A},$ $T_J=25\text{ }^\circ\text{C}$	-	0.9	1.3	V
Reverse recovery time <sup>2)</sup>	$t_{rr}$	$V_R=30\text{ V}, I_F=I_S,$ $di_F/dt=100\text{ A}/\mu\text{s}$	-	55	70	ns
Reverse recovery charge <sup>2)</sup>	$Q_{rr}$		-	96	120	

<sup>1)</sup> Current is limited by bondwire; with an  $R_{thJC} = 0.6\text{ K/W}$  the chip is able to carry 135 A at 25°C. For detailed information see Application Note ANPS071E at [www.infineon.com/optimos](http://www.infineon.com/optimos)

<sup>2)</sup> Defined by design. Not subject to production test.

<sup>3)</sup> See diagram 13.

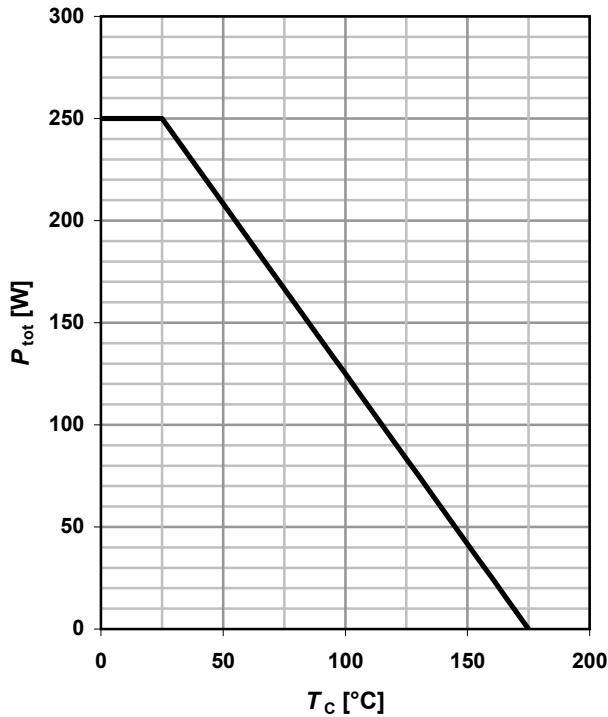
<sup>4)</sup> Qualified at -20V and +20V.

<sup>5)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.



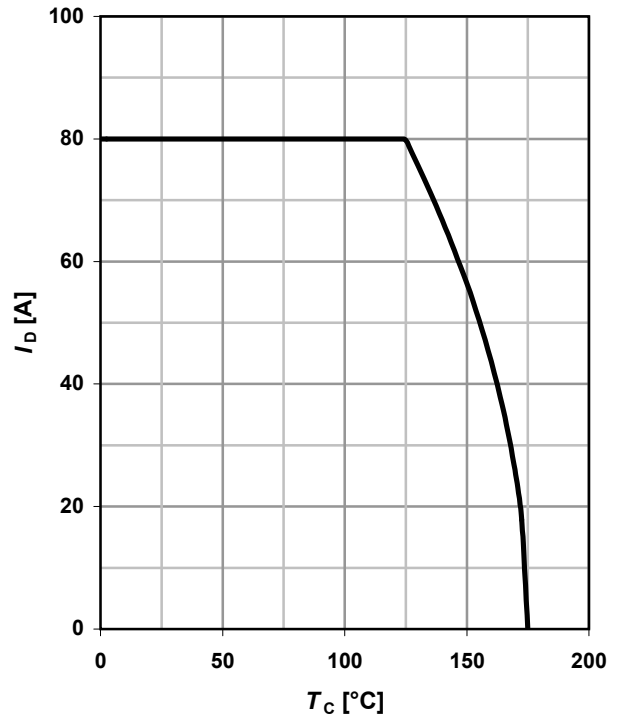
**1 Power dissipation**

$P_{tot} = f(T_C); V_{GS} \geq 6 V$



**2 Drain current**

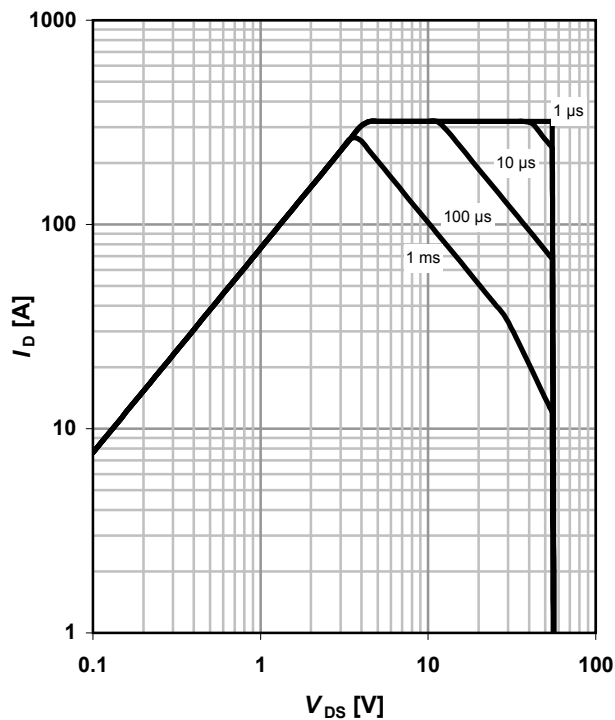
$I_D = f(T_C); V_{GS} \geq 10 V$



**3 Safe operating area**

$I_D = f(V_{DS}); T_C = 25\text{ °C}; D = 0$

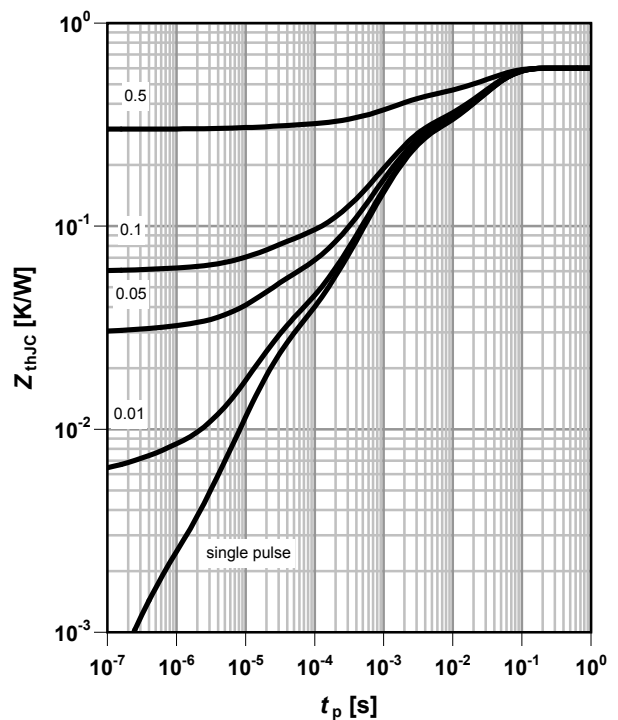
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJC} = f(t_p)$

parameter:  $D = t_p/T$

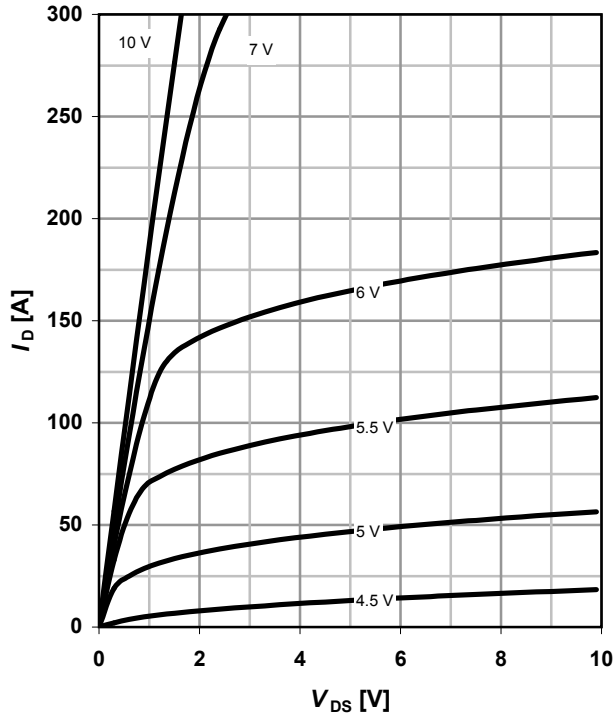




**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25\text{ }^\circ\text{C}$

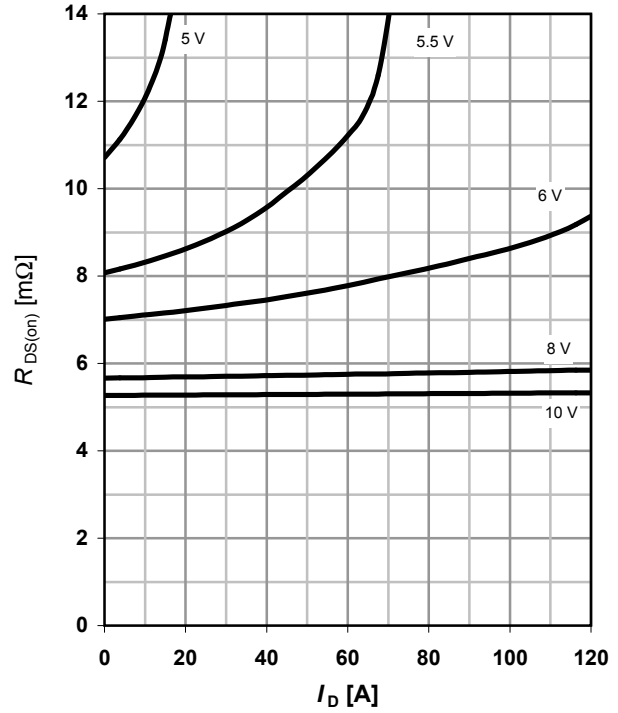
parameter:  $V_{GS}$



**6 Typ. drain-source on-state resistance**

$R_{DS(on)} = f(I_D); T_j = 25\text{ }^\circ\text{C}$

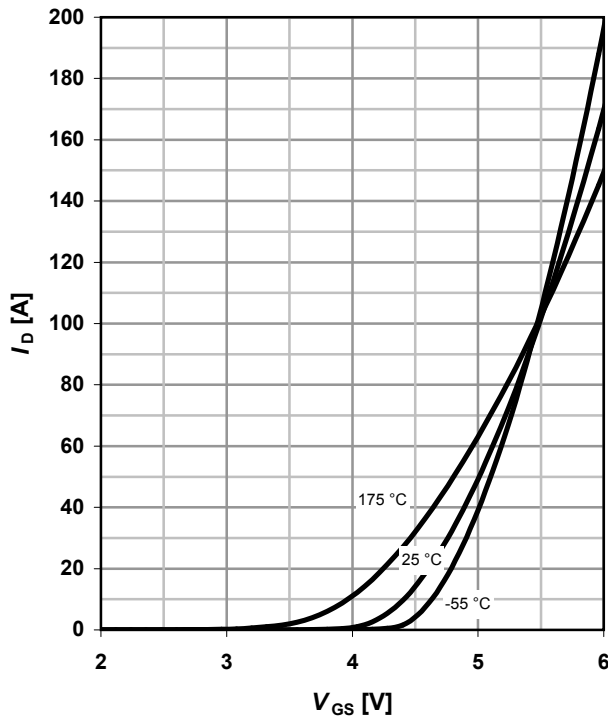
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

$I_D = f(V_{GS}); V_{DS} = 6\text{V}$

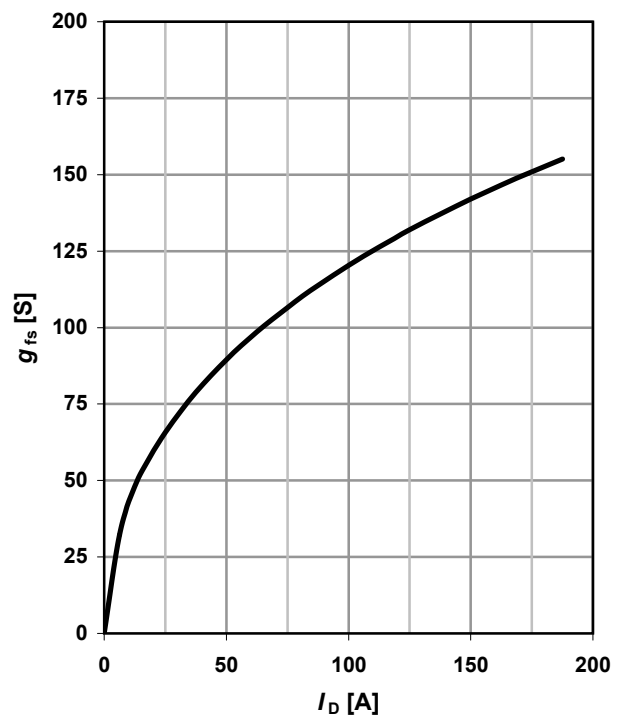
parameter:  $T_j$



**8 Typ. Forward transconductance**

$g_{fs} = f(I_D); T_j = 25\text{ }^\circ\text{C}$

parameter:  $g_{fs}$

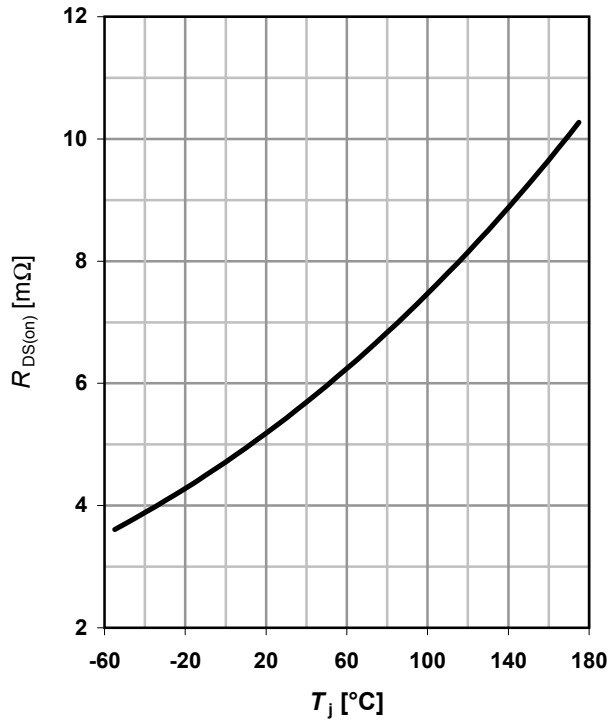




**9 Typ. Drain-source on-state resistance**

$R_{DS(ON)} = f(T_j)$

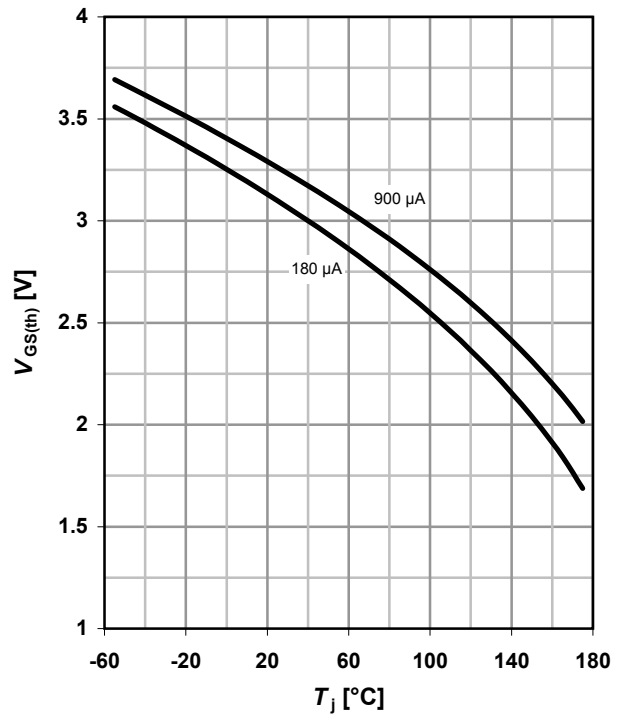
parameter:  $I_D = 80\text{ A}$ ;  $V_{GS} = 10\text{ V}$



**10 Typ. gate threshold voltage**

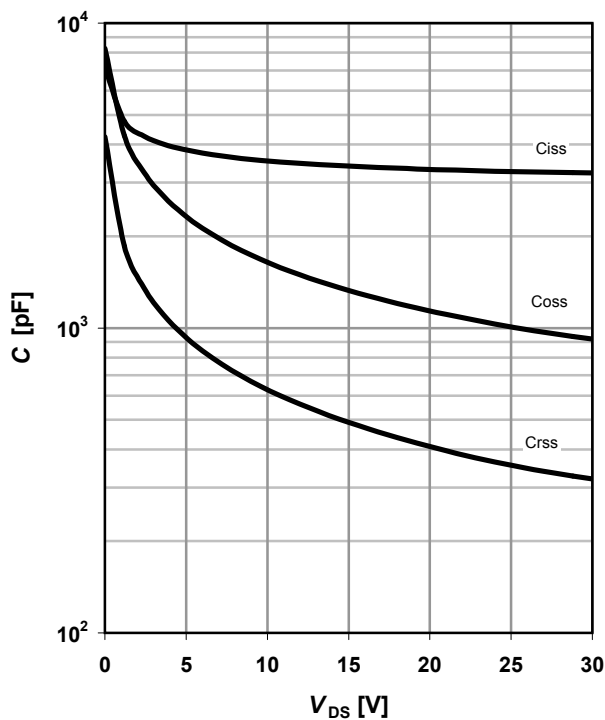
$V_{GS(th)} = f(T_j)$ ;  $V_{GS} = V_{DS}$

parameter:  $I_D$



**11 Typ. capacitances**

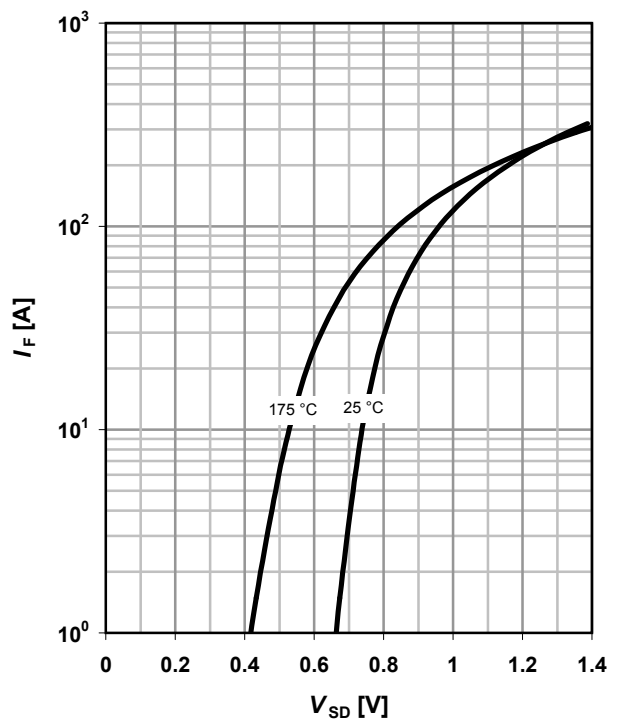
$C = f(V_{DS})$ ;  $V_{GS} = 0\text{ V}$ ;  $f = 1\text{ MHz}$



**12 Typical forward diode characteristics**

$I_F = f(V_{SD})$

parameter:  $T_j$



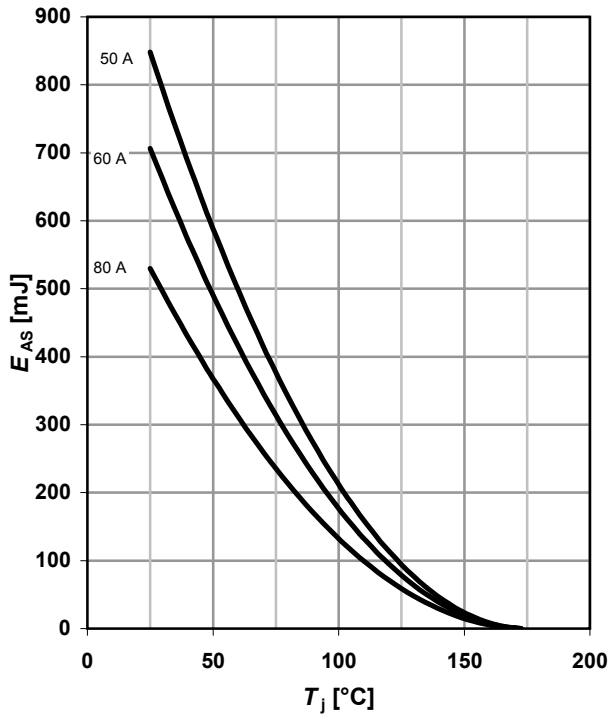




**13 Typical avalanche energy**

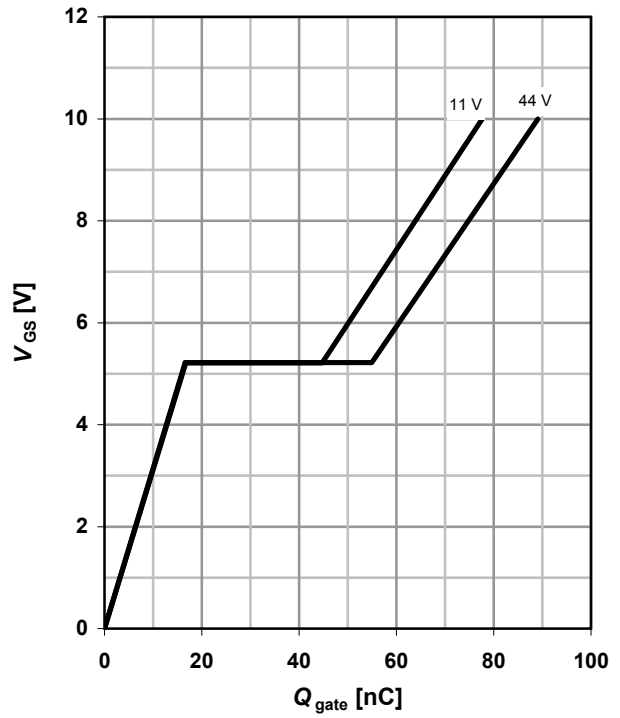
$E_{AS} = f(T_j)$

parameter:  $I_D$



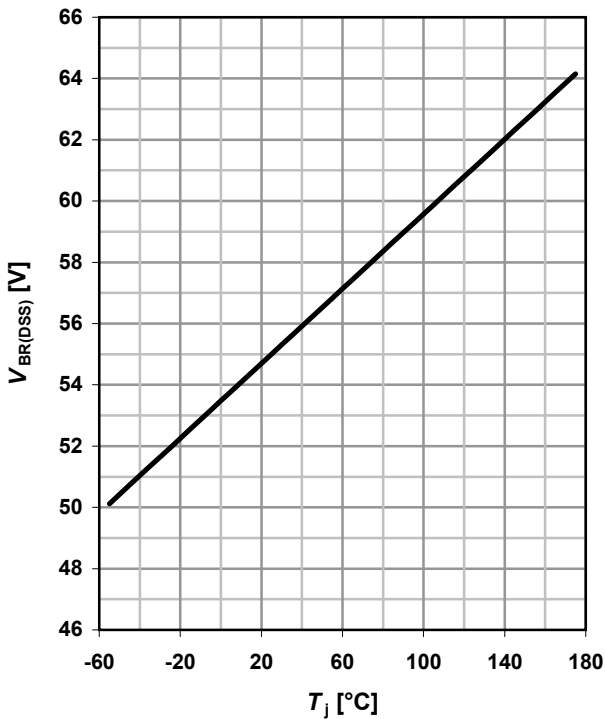
**14 Typ. gate charge**

$V_{GS} = f(Q_{gate}); I_D = 80 \text{ A pulsed}$

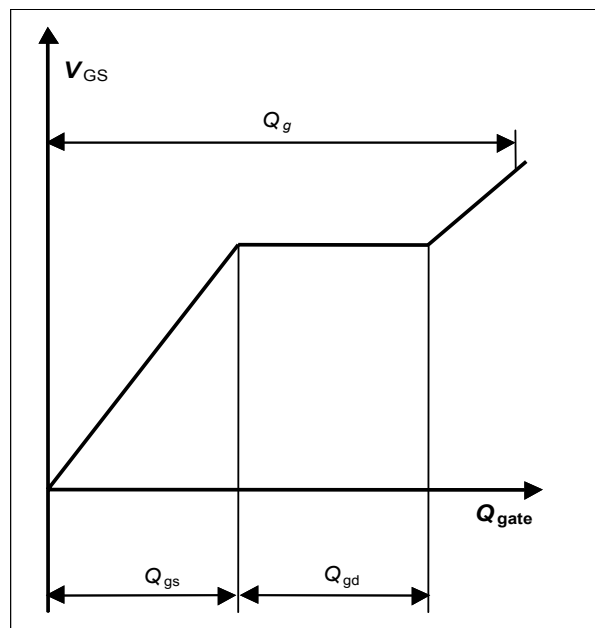


**15 Typ. drain-source breakdown voltage**

$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$



**16 Gate charge waveforms**





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